16 OUT 1

15 OUT₂

14 OUT₃

13 OUT₄

12 OUT₅

11 OUT₆

10 OUT₇

Dwg. PP-026A

9 OUT₈

Bimos II 8-BIT SERIAL-INPUT, LATCHED DRIVERS

A merged combination of bipolar and MOS technology gives these devices an interface flexibility beyond the reach of standard logic buffers and power driver arrays. The UCN5821A and UCN5821LW each have an eight-bit CMOS shift register and CMOS control circuitry, eight CMOS data latches, and eight bipolar current-sinking Darlington output drivers.

BiMOS II devices have much higher data-input rates than the original BiMOS circuits. With a 5 V logic supply, they will typically operate at better than 5 MHz. With a 12 V supply, significantly higher speeds are obtained. The CMOS inputs are compatible with standard CMOS and NMOS logic levels. TTL circuits may require the use of appropriate pull-up resistors. By using the serial data output, the drivers can be cascaded for interface applications requiring additional drive lines.

The UCN5821A are furnished in a standard 16-pin plastic DIP; the UCN5821LW are in a 16-lead wide-body SOIC for surface-mount applications. The UCN5821A is also available for operation from -40 $^{\circ}$ C to +85 $^{\circ}$ C. To order, change the prefix from 'UCN' to 'UCQ'.

ABSOLUTE MAXIMUM RATINGS at 25°C Free-Air Temperature

Note the DIP package and the SOIC package are

electrically identical and share common terminal

1

2

3

4 V_{DD}

5

6 ST

7 Œ

number assignments.

SUB

CLK _f

REGISTER

SHIFT

CLOCK

SERIAL

DATA IN

GROUND LOGIC

SUPPLY

SERIAL

STROBE

OUTPUT

ENABLE

POWER

GROUND

DATA OUT

LOGIC

Output Voltage, V _{OUT} 50 V
Logic Supply Voltage, V _{DD} 15 V
Input Voltage Range,
V_{IN} 0.3 V to V_{DD} + 0.3 V
Continuous Output Current,
I _{OUT} 500 mA
Package Power Dissipation, P _D
Package Code 'A' 2.1 W
Package Code 'LW' 1.5 W
Operating Temperature Range,
T _A 20°C to +85°C
Storage Temperature Range,
T _S 55°C to +150°C

Caution: CMOS devices have input static protection but are susceptible to damage when exposed to extremely high static electrical charges.

FEATURES

- To 3.3 MHz Data Input Rate
- CMOS, NMOS, TTL Compatible
- Internal Pull-Down Resistors
- Low-Power CMOS Logic & Latches
- High-Voltage Current-Sink Outputs
- Automotive Capable

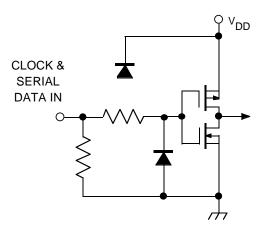
Always order by complete part number, e.g., UCN5821A.



5821 8-BIT SERIAL-INPUT, LATCHED DRIVERS

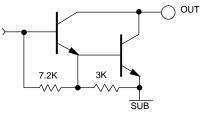
TYPICAL INPUT CIRCUITS STROBE & OUTPUT ENABLE

Dwg. EP-010-3

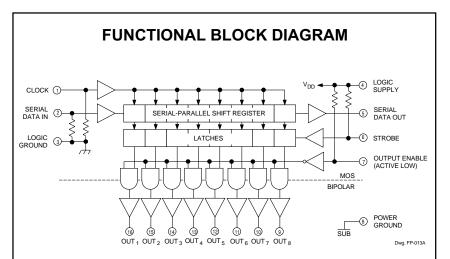


Dwg. EP-010-4A

TYPICAL OUTPUT DRIVER



Dwg. No. A-14,314



NOTE — There is an indeterminate resistance between logic ground and power ground. For proper operation, these terminals must be externally connected together.

Number of Outputs ON (I _{OUT} = 200 mA	UCN5821A Max. Allowable Duty Cycle at Ambient Temperature of								
V _{DD} = 12 V)	25°C	40°C	50°C	60°C	70°C				
8	90%	79%	72%	65%	57%				
7	100%	90%	82%	74%	65%				
6	100%	100%	96%	86%	76%				
5	100%	100%	100%	100%	91%				
4	100%	100%	100%	100%	100%				
3	100%	100%	100%	100%	100%				
2	100%	100%	100%	100%	100%				
1	100%	100%	100%	100%	100%				

Number of Outputs ON (I _{OUT} = 200 mA	UCN5821LW Max. Allowable Duty Cycle at Ambient Temperature of									
V _{DD} = 12 V)	25°C	40°C	50°C	60°C	70°C					
8	67%	59%	54%	49%	43%					
7	77%	68%	62%	56%	49%					
6	90%	79%	72%	65%	57%					
5	100%	95%	86%	78%	68%					
4	100%	100%	100%	98%	86%					
3	100%	100%	100%	100%	100%					
2	100%	100%	100%	100%	100%					
1	100%	100%	100%	100%	100%					

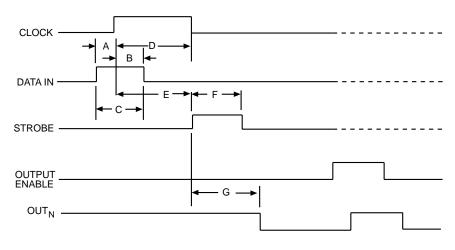


5821 8-BIT SERIAL-INPUT, LATCHED DRIVERS

ELECTRICAL CHARACTERISTICS at T_A = +25°C, V_{DD} = 5 V (unless otherwise specified).

				Limits	s	
Characteristic	Symbol	Test Conditions	Min.	Max.	Units	
Output Leakage	I _{CEX}	V _{OUT} = 50 V	_	50	μА	
Current		V _{OUT} = 50 V, T _A = +70°C	_	100	μΑ	
Collector-Emitter	V _{CE(SAT)}	I _{OUT} = 100 mA	_	1.1	V	
Saturation Voltage		I _{OUT} = 200 mA	_	1.3	V	
		$I_{OUT} = 350 \text{ mA}, V_{DD} = 7.0 \text{ V}$	_	1.6	V	
Input Voltage	V _{IN(0)}		_	0.8	V	
	V _{IN(1)}	V _{DD} = 12 V	10.5	_	V	
		V _{DD} = 5.0 V	3.5	_	V	
Input Resistance	r _{IN}	V _{DD} = 12 V	50	_	kΩ	
		V _{DD} = 5.0 V	50	_	kΩ	
Supply Current	I _{DD(ON)}	One Driver ON, V _{DD} = 12 V	_	4.5	mA	
		One Driver ON, V _{DD} = 10 V	_	3.9	mA	
		One Driver ON, V _{DD} = 5.0 V		2.4	mA	
	I _{DD(OFF)}	V _{DD} = 5.0 V, All Drivers OFF, All Inputs = 0 V	_	1.6	mA	
		V _{DD} = 12 V, All Drivers OFF, All Inputs = 0 V	_	2.9	mA	

5821 8-BIT SERIAL-INPUT, LATCHED DRIVERS



Dwg. No. A-12,627

TIMING CONDITIONS $(V_{DD} = 5.0 \text{ V}, T_A = +25^{\circ}\text{C}, \text{Logic Levels are } V_{DD} \text{ and Ground})$

Α.	Minimum Data Active Time Before Clock Pulse	
	(Data Set-Up Time)	75 ns
В.	Minimum Data Active Time After Clock Pulse	
	(Data Hold Time)	75 ns
C.	Minimum Data Pulse Width	150 ns
D.	Minimum Clock Pulse Width	150 ns
E.	Minimum Time Between Clock Activation and Strobe	30 ns
F.	Minimum Strobe Pulse Width	100 ns
G.	Typical Time Between Strobe Activation and	
	Output Transition	1.0 μ s

Serial Data present at the input is transferred to the shift register on the logic "0" to logic "1" transition of the CLOCK input pulse. On succeeding CLOCK pulses, the registers shift data information towards the SERIAL DATA OUTPUT. The SERIAL DATA must appear at the input prior to the rising edge of the CLOCK input waveform.

Information present at any register is transferred to its respective latch when the STROBE is high (serial-to-parallel conversion). The latches will continue to accept new data as long as the STROBE is held high. Applications where the latches are bypassed (STROBE tied high) will require that the ENABLE input be high during serial data entry.

When the ENABLE input is high, all of the output buffers are disabled (OFF) without affecting the information stored in the latches or shift register. With the ENABLE input low, the outputs are controlled by the state of the latches.

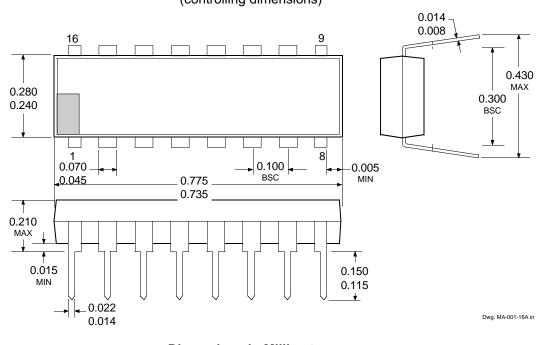
TRUTH TABLE

Serial		l	hift	Regi	ister Cont	ents	Serial	Ctuala		Lat	ch C	Contents	Output		Οι	ıtpu	t Contents	S
Data Input	Clock Input		l ₂	I ₃		I ₈	Output	Data Strobe - Output Input		l ₂	l ₃	l ₈	Output Enable	l ₁	l ₂	I ₃		I ₈
Н	4	Н	R ₁	R_2		R ₇	R ₇											
L	4	L	R_1	R_2		R ₇	R ₇											
Х	L	R ₁	R_2	R_3		R ₈	R ₈											
		Х	Χ	Χ		Χ	Х	L	R ₁	R ₂	R ₃	R ₈						
		P ₁	P ₂	P ₃		P ₈	P ₈	Н	P ₁	P ₂	P ₃	P ₈	L	P ₁	P ₂	P ₃		P ₈
									X	Χ	Χ	X	Н	Н	Н	Н		I

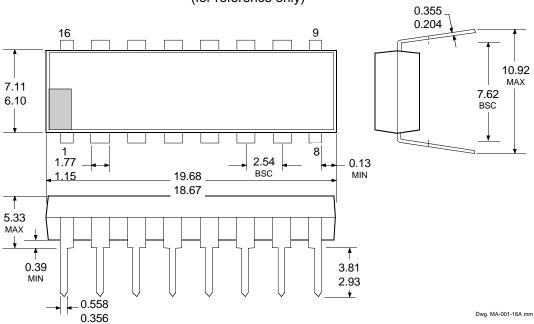
L = Low Logic Level H = High Logic Level X = Irrelevant P = Present State R = Previous State



UCN5821A Dimensions in Inches (controlling dimensions)



Dimensions in Millimeters (for reference only)

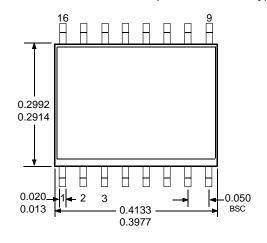


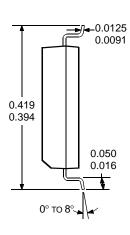
NOTES: 1. Lead thickness is measured at seating plane or below.

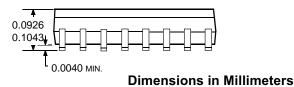
- 2. Lead spacing tolerance is non-cumulative.
- 3. Exact body and lead configuration at vendor's option within limits shown.

5821 8-BIT SERIAL-INPUT, LATCHED DRIVERS

UCN5821LW Dimensions in Inches (for reference only)

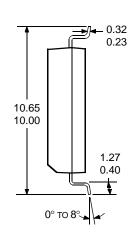


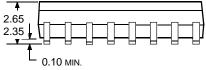




Dwg. MA-008-16A in

7.60 7.40 0.51 0.33 10.50 10.10 (controlling dimensions) 9 1.27 BSC





Dwg. MA-008-16A mm

NOTES: 1. Lead spacing tolerance is non-cumulative.

2. Exact body and lead configuration at vendor's option within limits shown.



5821 8-BIT SERIAL-INPUT, LATCHED DRIVERS

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